

# CY54/74FCT138T

SCCS013 - May 1994 - Revised February 2000

# 1-of-8 Decoder

#### **Features**

- Function, pinout, and drive compatible with FCT and F logic
- FCT-C speed at 5.0 ns max. (Com'l), FCT-A speed at 5.8 ns max. (Com'l)
- Reduced V<sub>OH</sub> (typically = 3.3V) versions of equivalent FCT functions
- Edge-rate control circuitry for significantly improved noise characteristics
- · Power-off disable feature
- ESD > 2000V
- · Matched rise and fall times
- Fully compatible with TTL input and output logic levels
- Extended commercial range of -40°C to +85°C
- Sink current 64 mA (Com'l), 32 mA (Mil)

Source current 32 mA (Com'l), 12 mA (Mil)

• Dual 1-of-8 decoder with enables

#### **Functional Description**

The FCT138T is a 1-of-8 decoder. The FCT138T accepts three binary weighted inputs (A<sub>0</sub>, A<sub>1</sub>, A<sub>2</sub>) and, when enabled, provides eight mutually exclusive active LOW outputs ( $\overline{O}_0$ – $\overline{O}_7$ ). The FCT138T features three enable inputs, two active LOW ( $\overline{E}_1$ ,  $\overline{E}_2$ ) and one active HIGH (E<sub>3</sub>).

All inputs will be HIGH unless  $\overline{E}_1$  and  $\overline{E}_2$  are LOW and  $E_3$  is HIGH. This multiple enable function allows easy parallel expansion of the device to a 1-of-32 (5 lines to 32 lines) decoder with just four FCT138T devices and one inverter.

The outputs are designed with a power-off disable feature to allow for live insertion of boards.

#### **Pin Configurations Logic Block Diagram** LCC DIP/SOIC/QSOP **Top View** Top View E3 NC E1 16 Vcc 7 6 5 4 A<sub>1</sub> $\square$ 2 $_{15} \rule[-4pt]{0mm}{1mm} \ \overline{O}_0$ $\overline{\mathsf{O}}_7$ A<sub>2</sub> 🔲 3 GND 5 10 14 □ Ō<sub>1</sub> NC NC 13 \overline{\overline{O}\_2} $\overline{\mathsf{O}}_{\mathsf{6}}$ $\overline{E}_2 \square_5$ 12 12 \overline{\overline{O}\_3} E<sub>3</sub> 6 11 04 14 15 16 17 $\overline{O}_7$ $\square$ 7 10 \ \overline{O}\_5 GND □8 9 \ \overline{O}\_6 0 N C O O FCT138T-2 FCT138T-3 $\overline{O}_{6}$ $\overline{O}_5$ Ō<sub>4</sub> $\overline{O}_3$ $\overline{O}_2$ $\overline{\Omega}_{4}$ $\overline{O}_{C}$ FCT138T-1

#### **Pin Description**

Name	Description
Α	Address Inputs
$\overline{E}_1 - \overline{E}_2$	Enable Inputs (Active LOW)
E <sub>3</sub>	Enable Input (Active HIGH)
0	Outputs



### Function Table<sup>[1]</sup>

		Inp	uts						Out	puts			
E <sub>1</sub>	E <sub>2</sub>	E <sub>3</sub>	A <sub>0</sub>	A <sub>1</sub>	A <sub>2</sub>	$\overline{O}_0$	$\overline{O}_{1}$	O <sub>2</sub>	$\overline{O}_3$	$\overline{O}_{4}$	$\overline{O}_5$	O <sub>6</sub>	$\overline{O}_7$
H X X	X H X	X X L	X X X	X X X	X X X	H H H	H H H	H H H	H H H	H H H	H H H	H H H	H H H
L L L	L L L	H H H	LHLH	LHH	L L L	L H H	H L H H	H H L H	H H L	H H H	H H H	H H H H	H H H
L L L	L L L	H H H	L H L	L L H	H H H	H H H	H H H	H H H	H H H	L H H	H L H	H H L	H H H L

# Maximum Ratings<sup>[2, 3]</sup>

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature .....-65°C to +150°C Ambient Temperature with Power Applied ......-65°C to +135°C

Supply Voltage to Ground Potential .....-0.5V to +7.0V DC Input Voltage.....-0.5V to +7.0V DC Output Voltage ...... -0.5V to +7.0V

DC Output Current (Maximum Sink Current/Pin)......120 mA

Static Discharge Voltage.....>2001V (per MIL-STD-883, Method 3015)

## **Operating Range**

Range	Range	Ambient Temperature	v <sub>cc</sub>
Commercial	All	-40°C to +85°C	5V ± 5%
Military <sup>[4]</sup>	All	–55°C to +125°C	5V ± 10%

#### **Electrical Characteristics** Over the Operating Range

Parameter	Description	Test Condition	าร	Min.	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> =Min., I <sub>OH</sub> =–32 mA	Com'l	2.0			V
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> =Min., I <sub>OH</sub> =–15 mA	Com'l	2.4	3.3		V
$V_{OH}$	Output HIGH Voltage	V <sub>CC</sub> =Min., I <sub>OH</sub> =-12 mA	Mil	2.4	3.3		V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> =Min., I <sub>OL</sub> =64 mA	Com'l		0.3	0.55	V
		V <sub>CC</sub> =Min., I <sub>OL</sub> =32 mA	Mil		0.3	0.55	V
V <sub>IH</sub>	Input HIGH Voltage			2.0			V
V <sub>IL</sub>	Input LOW Voltage					0.8	V
V <sub>H</sub>	Hysteresis <sup>[6]</sup>	All inputs			0.2		V
V <sub>IK</sub>	Input Clamp Diode Voltage	V <sub>CC</sub> =Min., I <sub>IN</sub> =–18 mA			-0.7	-1.2	V
I <sub>I</sub>	Input HIGH Current	V <sub>CC</sub> =Max., V <sub>IN</sub> =V <sub>CC</sub>				5	μΑ
I <sub>IH</sub>	Input HIGH Current	V <sub>CC</sub> =Max., V <sub>IN</sub> =2.7V				±1	μΑ
I <sub>IL</sub>	Input LOW Current	V <sub>CC</sub> =Max., V <sub>IN</sub> =0.5V				±1	μΑ
I <sub>OS</sub>	Output Short Circuit Current <sup>[7]</sup>	V <sub>CC</sub> =Max., V <sub>OUT</sub> =0.0V		-60	-120	-225	mA
I <sub>OFF</sub>	Power-Off Disable	V <sub>CC</sub> =0V, V <sub>OUT</sub> =4.5V				±1	μΑ

#### Notes:

- 1. 2. 3.
- $H = HIGH\ Voltage\ Level.\ L = LOW\ Voltage\ Level.\ X = Don't\ Care.$  Unless otherwise noted, these limits are over the operating free-air temperature range. Unused inputs must always be connected to an appropriate logic voltage level, preferably either  $V_{CC}$  or ground.
- $T_A$  is the "instant on" case temperature. Typical values are at  $V_{CC}$ =5.0V,  $T_A$ =+25°C ambient. This parameter is specified but not tested.
- Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.



# Capacitance<sup>[6]</sup>

Parameter	Description	Typ. <sup>[5]</sup>	Max.	Unit
C <sub>IN</sub>	Input Capacitance	5	10	pF
C <sub>OUT</sub>	Output Capacitance	9	12	pF

# **Power Supply Characteristics**

Parameter	Description	Test Conditions	Typ. <sup>[5]</sup>	Max.	Unit
I <sub>CC</sub>	Quiescent Power Supply Current	$V_{CC}$ =Max., $V_{IN}$ ≤0.2V, $V_{IN}$ ≥ $V_{CC}$ -0.2V	0.1	0.2	mA
Δl <sub>CC</sub>	Quiescent Power Supply Current (TTL inputs)	V <sub>CC</sub> =Max., V <sub>IN</sub> =3.4V, <sup>[8]</sup> f <sub>1</sub> =0, Outputs Open	0.5	2.0	mA
I <sub>CCD</sub>	Dynamic Power Supply Current <sup>[9]</sup>	$V_{CC}=$ Max., One Input Toggling, 50% Duty Cycle, Outputs Open, $V_{IN} \le 0.2 V$ or $V_{IN} \ge V_{CC}-0.2 V$	0.06	0.12	mA/MHz
I <sub>C</sub>	Total Power Supply Current <sup>[10]</sup>	$\begin{array}{c} V_{CC}\text{=}Max., \ f_1\text{=}10 \ MHz, \\ 50\% \ Duty \ Cycle, \ Outputs \ Open, \ Toggle \\ \overline{E}_1, \ \overline{E}_2, \ or \ E_3, \ One \ Output \ Toggling, \\ V_{IN} \leq 0.2V \ or \ V_{IN} \geq V_{CC}\text{-}0.2V \end{array}$	0.7	1.4	mA
		$V_{CC}$ =Max., $f_1$ =10 MHz, 50% Duty Cycle, Outputs Open, Toggle $\overline{E}_1$ , $\overline{E}_2$ , or $E_3$ , One Output Toggling, $V_{IN}$ =3.4V or $V_{IN}$ =GND	1.0	2.4	mA

#### Notes:



# Switching Characteristics Over the Operating Range

		FCT138T		FCT138AT			
		Comme	ercial	Commercial			Fig
Parameter	Description	Min. <sup>[11]</sup>	Max.	Min. <sup>[11]</sup>	Max.	Unit	Fig. No. <sup>[12]</sup>
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay A to O	1.5	9.0	1.5	5.8	ns	1, 2
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay $\overline{E}_1$ or $\overline{E}_2$ to $\overline{O}$	1.5	9.0	1.5	5.9	ns	1, 5
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay E <sub>3</sub> to O	1.5	9.0	1.5	5.9	ns	1, 5

		FCT138CT					
		Military		Commercial			
Parameter	Description	Min. <sup>[11]</sup>	Max.	Min. <sup>[11]</sup>	Max.	Unit	Fig. No. <sup>[12]</sup>
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay A to $\overline{O}$	1.5	6.0	1.5	5.0	ns	1, 2
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay $\overline{\mathbb{E}}_1$ or $\overline{\mathbb{E}}_2$ to $\overline{\mathbb{O}}$	1.5	6.1	1.5	5.0	ns	1, 5
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay $E_3$ to $\overline{O}$	1.5	6.1	1.5	5.0	ns	1, 5

# **Ordering Information**

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
5.0	CY74FCT138CTQCT	Q1	16-Lead (150-Mil) QSOP	Commercial
	CY74FCT138CTSOC/SOCT	S1	16-Lead (300-Mil) Molded SOIC	
5.8	CY74FCT138ATQCT	Q1	16-Lead (150-Mil) QSOP	Commercial
	CY74FCT138ATSOC/SOCT	S1	16-Lead (300-Mil) Molded SOIC	
6.0	CY54FCT138CTLMB	L61	20-Pin Square Leadless Chip Carrier	Military
9.0	CY74FCT138TQCT	S1	16-Lead (150-Mil) QSOP	Commercial

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Minimum limits are specified but not tested on Propagation Delays.
See "Parameter Measurement Information" in the General Information Section.

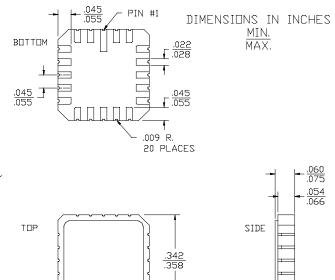


# **Package Diagrams**

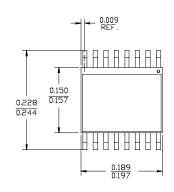
# **16-Lead (300-Mil) CerDIP D2** MIL-STD-1835 D-2 Config.A

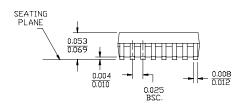
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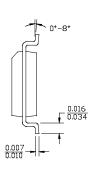
#### 20-Pin Square Leadless Chip Carrier L61 MIL-STD-1835 C-2A



16-Lead Quarter Size Outline Q1





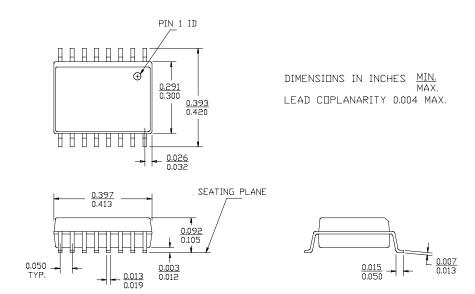


DIMENSIONS IN INCHES  $\frac{\text{MIN.}}{\text{MAX.}}$ LEAD COPLANARITY 0.004 MAX.



# Package Diagrams (continued)

#### 16-Lead Molded SOIC S1



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